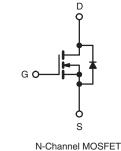


Power MOSFET

PRODUCT SUMMAI	RY			
V _{DS} (V)	600			
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.60		
Q _g (Max.) (nC)	84			
Q _{gs} (nC)	18			
Q _{gd} (nC)	36			
Configuration	Single			





FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30 V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Isolated Central Mounting Hole
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing advanced Power MOSFET technology the device improvements allow for reduced gate drive requirements, faster switching speeds and increased total system savings. These device improvements combined with the proven ruggedness and reliability of Power MOSFETs offer the designer a new standard in power transistors for switching applications.

TO-247AC The package preferred for is commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPC50LCPbF
	SiHFPC50LC-E3
SnPb	IRFPC50LC
	SiHFPC50LC

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage		V _{GS}	± 30	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	l-	11	
Continuous Drain Current	VGS at TO V	T _C = 100 °C	ID	7.3	A
Pulsed Drain Current ^a	•		I _{DM}	44	
Linear Derating Factor			1.5	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	920	mJ
Repetitive Avalanche Current ^a			I _{AR}	11	A
Repetitive Avalanche Energy ^a			E _{AR}	19	mJ
Maximum Power Dissipation	T _C =	25 °C	PD	190	W
Peak Diode Recovery dV/dtc			dV/dt	3.0	V/ns
Operating Junction and Storage Temperature Rang	e		T _J , T _{stg}	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature) for 10 s			300 ^d		
Mounting Torque	6 32 or 1	//3 screw		10	lbf ∙ in
Mounting Torque	0-32 OF 1	NO SCIEW	ľ	1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 13 mH, $R_g = 25 \Omega$, $I_{AS} = 11 \text{ A}$ (see fig. 12). c. $I_{SD} \le 11 \text{ A}$, dI/dt $\le 100 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$. d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91242 S11-0443-Rev. B, 14-Mar-11

AIMERS, SET FORTH AT www.vishav.com/doc?91000



RoHS

COMPLIANT

Vishay Siliconix



THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	- 40 0.24 - - 0.65				°C/W		
Case-to-Sink, Flat, Greased Surface	R _{thCS}							
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS $(T_J = 25 \degree C, 1)$	unless otherw	vise noted)						
PARAMETER	SYMBOL		CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static						•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0	V, I _D = 2	50 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to	o 25 °C,	I _D = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{C}$	_{3S} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS}	$s = \pm 20$	V	-	-	± 100	nA
		V _{DS} = 60	00 V, V _{GS}	s = 0 V	-	-	25	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 V, V	_{GS} = 0 V,	T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 6.6 A ^b		-	-	0.60	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 100 \text{ V}, \text{ I}_{D} = 6.6 \text{ A}^{b}$		7.0	-	-	S	
Dynamic					1	I		
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	2300	-	pF	
Output Capacitance	C _{oss}			-	270	-		
Reverse Transfer Capacitance	C _{rss}	f = 1.0 N	/Hz, see	fig. 5	-	28	-	1
Total Gate Charge	Qg				-	-	84	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		A, V _{DS} = 360 V, iq. 6 and 13 ^b	-	-	18	nC
Gate-Drain Charge	Q _{gd}		3001	ig. o and to	-	-	36	
Turn-On Delay Time	t _{d(on)}				-	17	-	
Rise Time	t _r	V _{DD} = 30	0 V I	11 A	-	32	-	ns
Turn-Off Delay Time	t _{d(off)}	$R_{g} = 6.2 \Omega, R_{E}$			-	41	-	
Fall Time	t _f				-	26	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") fror			-	5.0	-	
Internal Source Inductance	Ls	package and cer die contact	nter of		-	13	-	nH
Drain-Source Body Diode Characteristic	s				1	I		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	11	_	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction dic	ode		-	-	44	A
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S	s = 11 A,	V _{GS} = 0 V ^b	-	-	1.4	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = ⁻	11 A J/	1+ - 100 A (uch	-	590	890	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 23$ C, $I_{\rm F} =$	A, ui/0	μι = 100 Αγμ5 ⁵	-	4.5	6.8	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-	on time i	is negligible (turn	-on is do	minated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

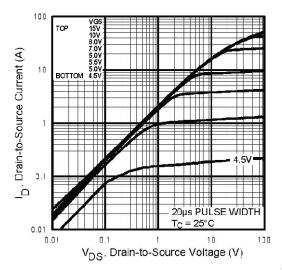
b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

www.vishay.com 2

Document Number: 91242 S11-0443-Rev. B, 14-Mar-11



Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

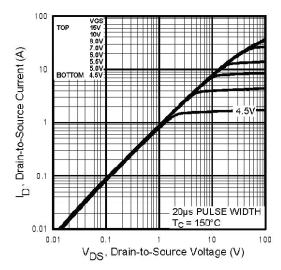


Fig. 2 - Typical Output Characteristics, T_C = 150 $^\circ C$

THE PRODUCT DESCRIBED HEREIN AND THIS DATASH Downloaded From Oneyac.com

This detection of the observer without active.

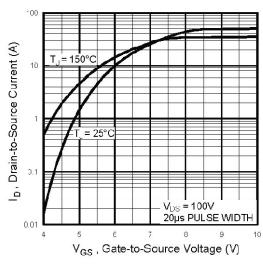


Fig. 3 - Typical Transfer Characteristics

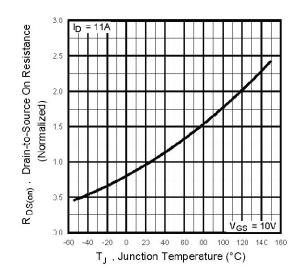


Fig. 4 - Normalized On-Resistance vs. Temperature

AIMERS, SET FORTH AT www.vishay.com/doc?91000

Vishay Siliconix



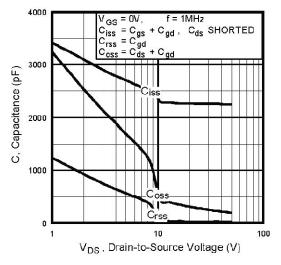


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

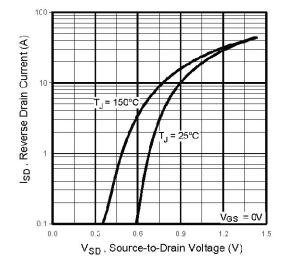


Fig. 7 - Typical Source-Drain Diode Forward Voltage

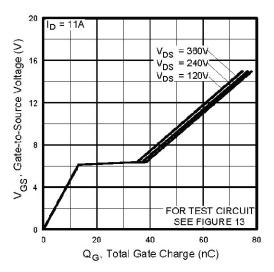


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

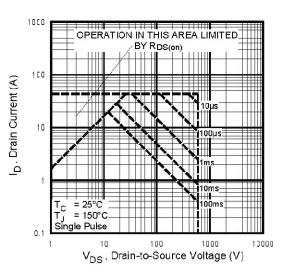


Fig. 8 - Maximum Safe Operating Area

Document Number: 91242 S11-0443-Rev. B, 14-Mar-11

This datasheet is subject to shance without notice. THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEE Downloaded From Oneyac.com // IERS, SET FORTH AT www.vishay.com/doc?91000



Vishay Siliconix

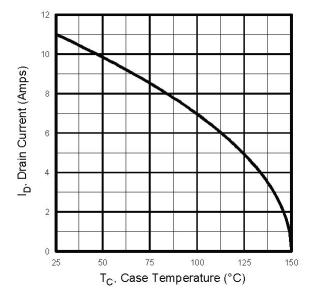


Fig. 9 - Maximum Drain Current vs. Case Temperature

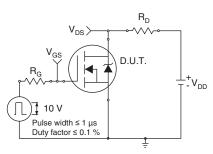


Fig. 10a - Switching Time Test Circuit

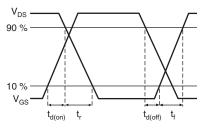


Fig. 10b - Switching Time Waveforms

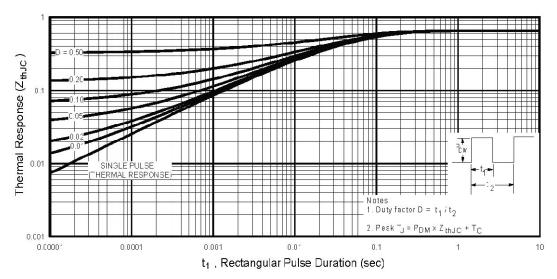


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

This detection of the observer without active.

THE PRODUCT DESCRIBED HEREIN AND THIS DATASH Downloaded From Oneyac.com

AIMERS, SET FORTH AT www.vishay.com/doc?91000

Vishay Siliconix



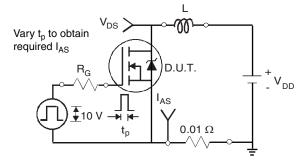
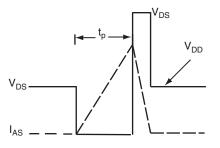
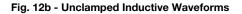


Fig. 12a - Unclamped Inductive Test Circuit





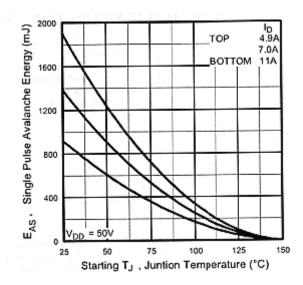
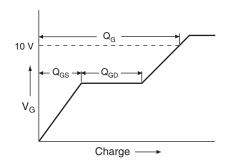


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





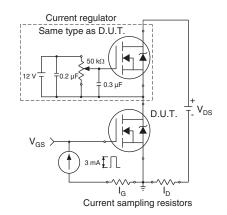


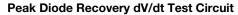
Fig. 13b - Gate Charge Test Circuit

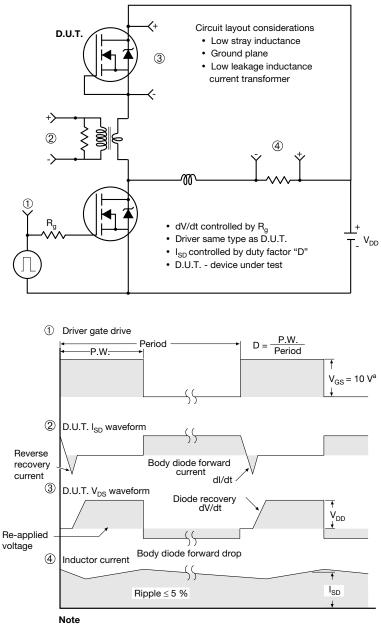
www.vishay.com 6 Document Number: 91242 S11-0443-Rev. B, 14-Mar-11

This datasheet is subject to shance without patice.
THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEE Downloaded From Oneyac.com // MERS, SET FORTH AT www.vishay.com/doc?91000



Vishay Siliconix





a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91242.

Document Number: 91242 S11-0443-Rev. B, 14-Mar-11

c.com AIMERS, SET FORTH AT www.vishay.com/doc?91000



TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

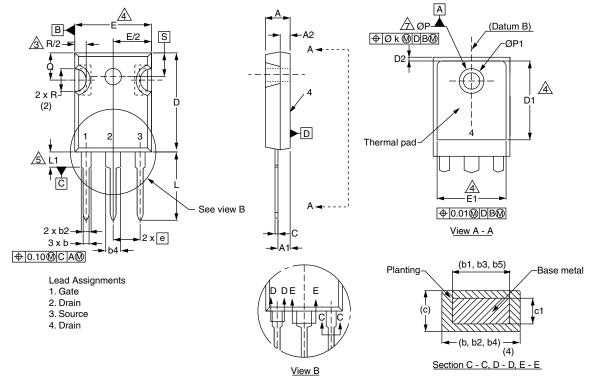
	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØР	3.56	3.65	7
Ø P1	7.19) ref.	
Q	5.31	5.69	
S	5.54	5.74	

Notes

- ⁽¹⁾ Package reference: JEDEC[®] TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- (4) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
с	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

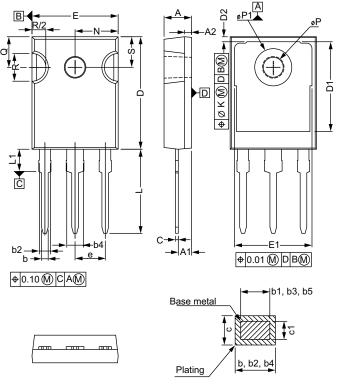
	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØΡ	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- ⁽³⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- ⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c



VERSION 3: FACILITY CODE = N



	MILLIN	IETERS		MILLIN	IETERS
DIM.	MIN.	MAX.	DIM.	MIN.	MAX.
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	е	5.46	BSC
b1	0.99	1.35	k	0.:	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)